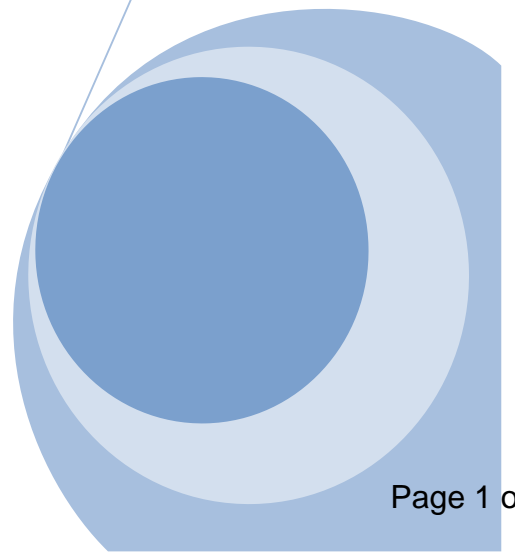


**Data Sheets of SMD Type
Full Color LED**

Model : YL-5050F-DS00 Series



Top View LED with Reflector

1. FEATURES

- High intensity with small package,
- Wide viewing angle (120°)
- Package Outline (L×W×H)=5.0×5.0×1.3 mm
- Technology : Blue&Green is InGaN, Red is AlInGaP
- Dominant Wavelength : Red=625nm, G=526nm, B=466nm
- Suitable for all SMT assembly methods
- Suitable for all soldering methods
- Delivery on 12mm tape reels

2. APPLICATIONS

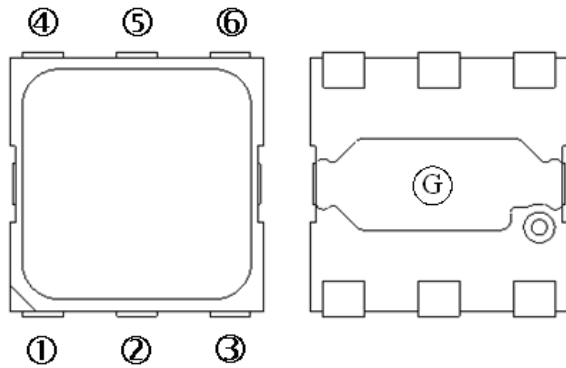
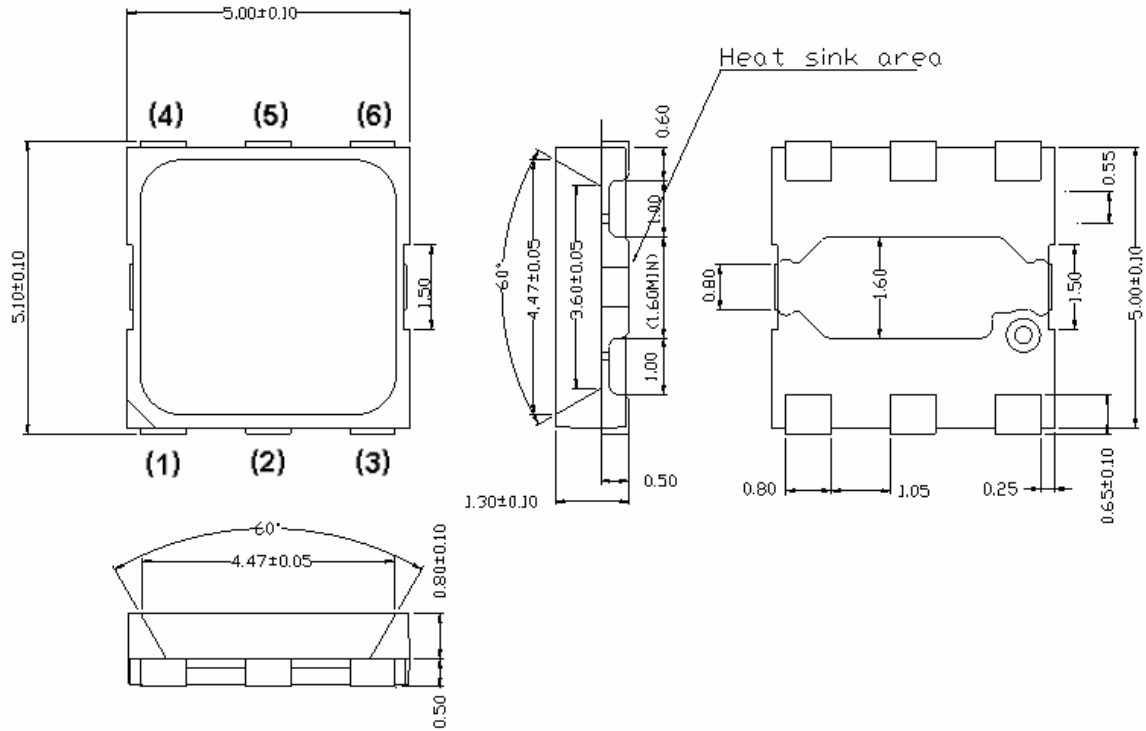
- Automotive: indoor/outdoor lighting.
- Signal and symbol lightings
- All applications in notice high intensities are required
- Strobe Light
- Channel Letter
- Decorative Light

3. DEVICES PACKAGE

ITEM	MATERIALS
Package	Heat-Resistant Polymer
Encapsulating	Heat Resistance Resin
Electrodes	Ag Plating Copper Alloy

Type	Color of Emission	Color of the Light Emitting Area	Luminous intensity I _v (mcd) I _F =150/150/150mA
YL-5050F-DS00	Red	Full Color	2500-4250
	Green		7200-10000
	Blue		1650-3000

4. OUTLINE DIMENSION:



Pin No.	Function
1	R- -
2	G- -
3	B- -
4	R- +
5	G- +
6	B- +
G	heat sink

Note:

1. Unit: mm

2. Tolerance: Dimension ± 0.1 / Angle $\pm 0.5^\circ$

5. ABSOLUTE MAXIMUM RATINGS ($T_A=25^{\circ}\text{C}$)

Parameter	Symbol	Absolute Max. Rating		Unit
		Blue/Green	Red	
Reverse Voltage	V_R	5	5	V
Forward Current	I_F	250	250	mA
Operating Temperature	T_{opr}	-40 ~ +100		$^{\circ}\text{C}$
Storage Temperature	T_{stg}	-40 ~ +100		$^{\circ}\text{C}$
Soldering Temperature	T_{sol}	260 (for 5 sec)		$^{\circ}\text{C}$
Power Dissipation	P_D	1000	700	mW
Peak Forward Current (Duty 1/10 @ 1KHz)	$I_{F(peak)}$	350	350	mA
Junction temperature	T_j	100	110	$^{\circ}\text{C}$

6. ELECTRONIC OPTICAL CHARACTERISTICS

Parameter	Symbol	Condition	R	G	B	Unit
Dominant Wavelength	λ_d	$I_F=150\text{mA}$	623±6	526±8	463±7	nm
Peak Wavelength	λ_p	$I_F=150\text{mA}$	632	532	469	nm
Spectral bandwidth at 50% $I_{Vrel\ max}$	$\Delta \lambda$	$I_F=150\text{mA}$	20	30	25	nm
Forward Voltage	V_F	$I_F=150\text{mA}$	2.1(Typ.) 2.5(Max.)	3.30(Typ.) 3.60(Max.)		V
View Angle	$2\theta_{1/2}$	$I_F=150\text{mA}$	120			Degree
Leakage Current (Without zener diode)	I_r	$V_r= 5V$	50(Max.)			μA

7. LUMINOUS INTENSITY GROUPS:

Measurement condition @150mA, Ta=25°C								
R			G			B		
Bin	Iv(cd)	ΦV(lm)	Bin	Iv(cd)	ΦV(lm)	Bin	Iv(cd)	ΦV(lm)
W4	4.25-5	12.75-15	W7	7.2-8.4	21.6-25.2	U3	1.65-2.05	4.95-6.15
W5	5-6	15-18	W8	8.4-10	25.2-30	U4	2.05-2.5	6.15-7.5
W6	6-7.2	18-21.6				W1	2.5-3	7.5-9

- * Luminous intensity each group (R, G&B) include 3 groups .
- * Luminous intensity is tested at a current pulse duration of 25ms and a tolerance of $\pm 10\%$

8. WAVELENGTH GROUPS (Dominant Wavelength) :

Measurement condition @150mA, Ta=25°C					
R		G		B	
Bin	λd(nm)	Bin	λd(nm)	Bin	λd(nm)
r12-r56	620-632	g12-g78	520-536	b12-b56	458-470

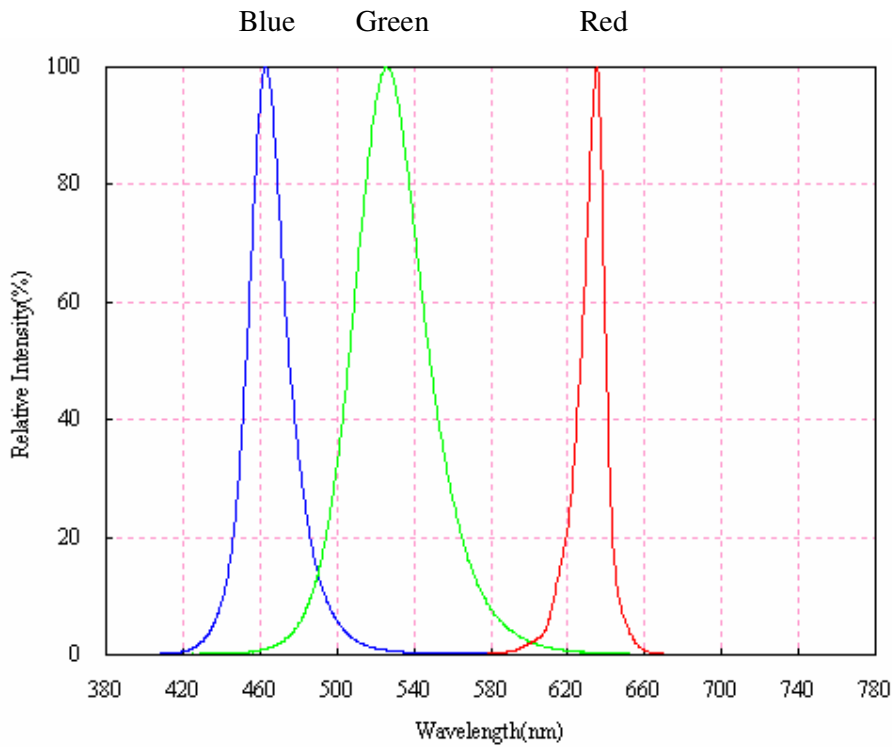
- * Dominant Wavelength tolerance ± 2.0 nm.
- * Wavelength measuring equipment (Correction) : CAS 140B(Instrument System).
- * Dominant Wavelength can be sorted by 4.0nm.

9. FORWARD VOLTAGE

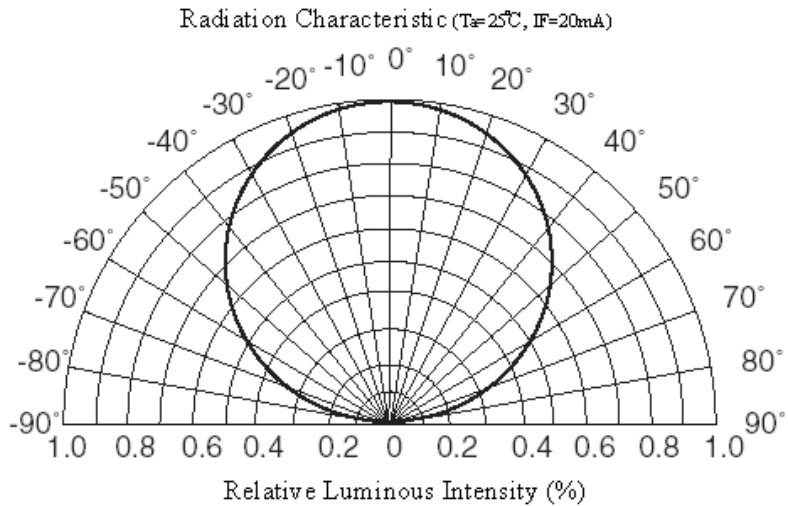
Measurement condition @150mA, Ta=25°C				
Forward Voltage VF(Volt)				Forward Current IF (mA)
Bin	G/B	Bin	R	
V05	3.0-3.6	Vme	1.8-2.6	150mA

- * Forward Voltage tolerance ± 0.1 Volt.

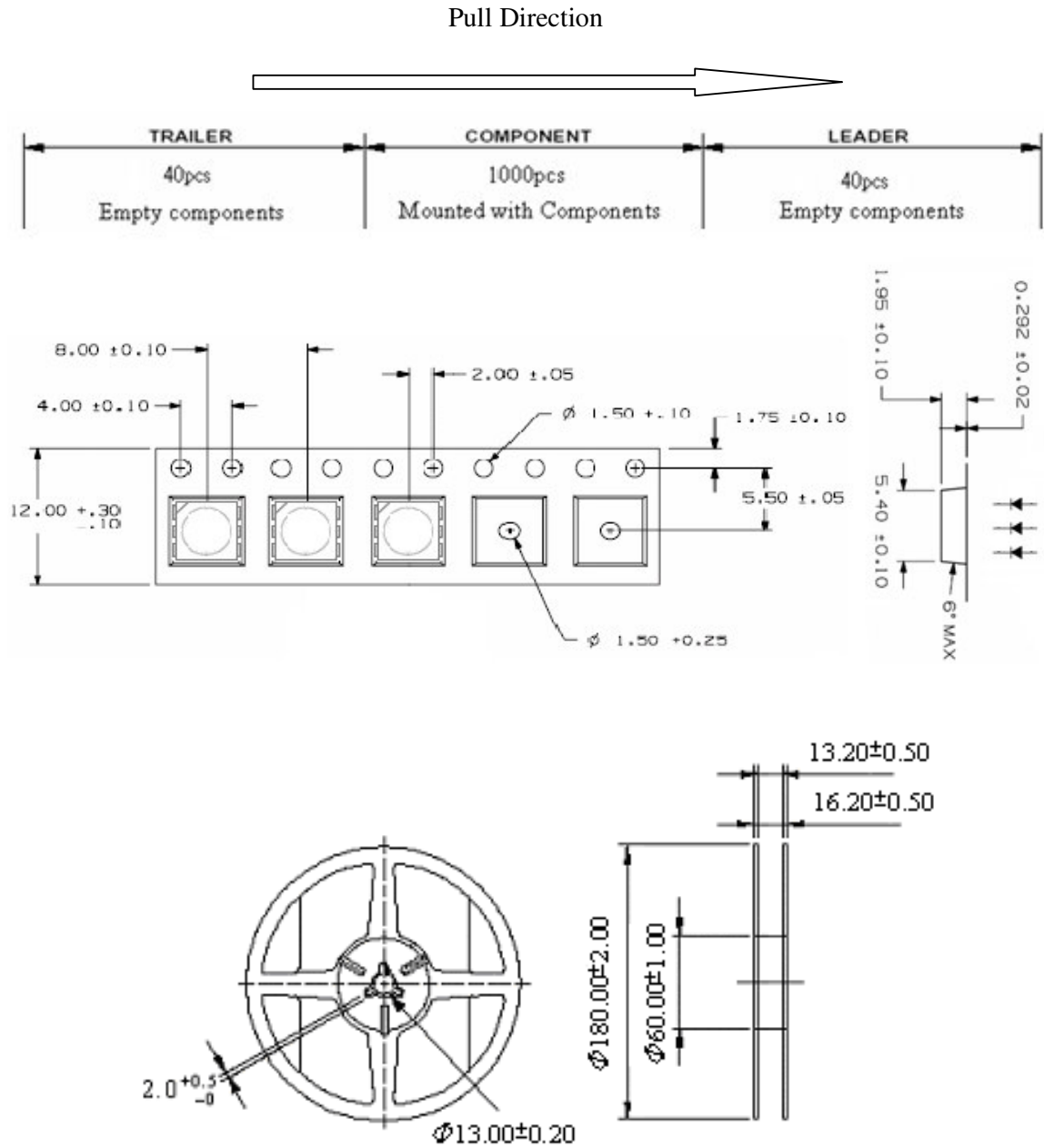
10. * Spectrum @ 150mA, 25°C



*** Radiation Characteristic (@ 25°C, 150mA)**



11. REEL PACKAGE:



Note:

1. Unit: mm
2. 1,000 pcs / reel

12. RELIABILITY PLAN:

* The reliability of products shall be satisfied with items listed below.

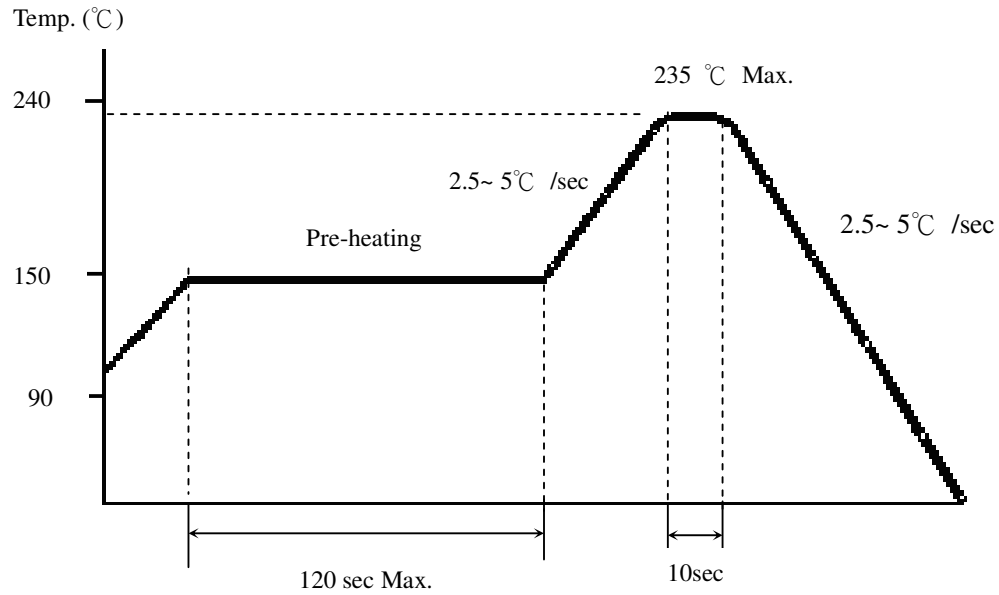
Confidence Level : 90 % , LTPD : 10 %

No	Test Item	Description & Condition		Sample size	Ac/Re	Failure Criteria
1	Solderability	Tsld = 235±5°C, 10sec,	1 time	22	0/1	IV < L * 0.6 (I _F : 150mA)
2	Room Temperature operating	Ta = 25 °C I _F = 150mA	1000 hrs	22	0/1	
3	Room Temperature operating	Ta = 25 °C I _F = 150mA	500 hrs	22	0/1	V _F > U * 1.1 (I _F : 150mA)
4	Low Temperature Storage	Ta = -40 °C	1000 hrs	22	0/1	I _R > U * 2.0 (V _R :5V)
5	High Temperature Storage	Ta = 100 °C	1000 hrs	22	0/1	L: Lower Spec. Level U: Upper Spec. Level
6	Temperature Cycle	-40°C ~25°C ~100°C~25 °C 30min 5min 30min 5 min	100 cycles	22	0/1	
7	High Humidity Heat	Ta = 60 °C RH=90% I _F = 150mA	500 hrs	22	0/1	

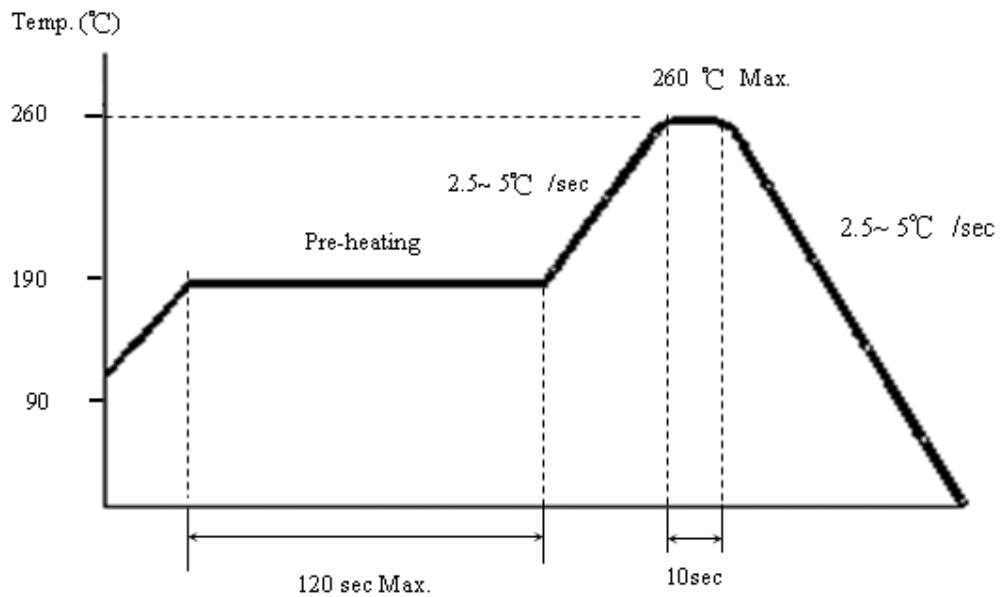
13. SOLDERING CONDITIONS:

(1) Recommended Re-flow profile

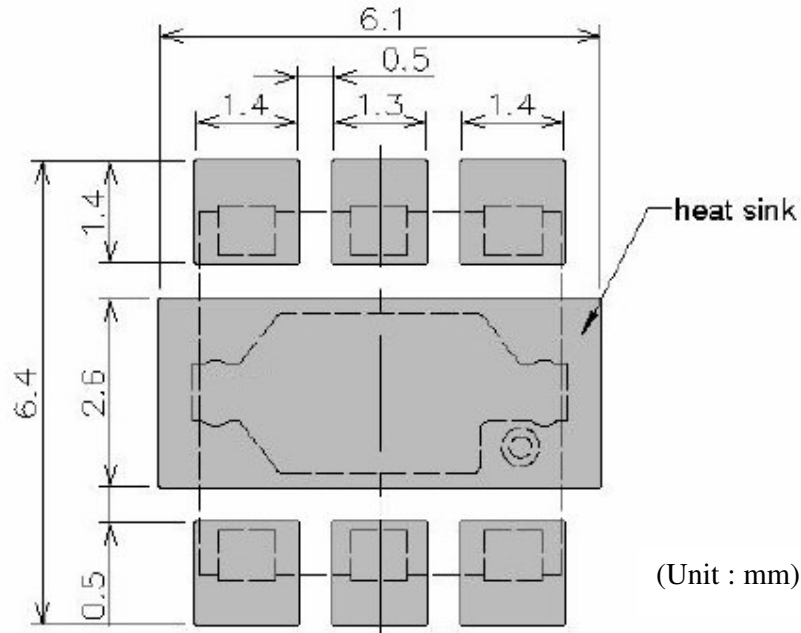
(A) Lead Solder Profile



(B) Lead-free Solder Profile



Recommended Soldering Pad



- (2) Re-flow soldering should not be done more than two times.
- (3) It is recommended that the user use the nitrogen reflow method.
- (4) When soldering, don't put stress on the LEDs during heating.
- (5) After soldering, don't warp the circuit board.
- (6) It is recommended that isopropyl alcohol (IPA) be used as a solvent for cleaning the LEDs.

14.CAUTIONS:

(1)Storage

- Before opening the package :

The LEDs should be kept at 30°C or less and 30%RH~85%RH. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with desiccant (Silica gel)is recommended.

- After opening the package :

The LEDs should be kept at 30°C or less and 30%RH~70%RH.The LEDs should be soldered within 168hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture desiccant (Silica gel), or reseal the moisture proof bag again.

If the moisture desiccant (Silica gel)has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 24 hours at 60°C on tap and reel, 7 hours at 125°C have no reel&tap.

Please avoid conditions which may cause the LED to corrode, tarnish or discol1or. This corrosion or discoloration might lower solderability or might effect on optical characteristics.-Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

- Moisture Proof package

When moisture is absorbed into the SMT package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package. A package of a moisture desiccant (silica gel) is inserted into the moisture proof bag-The silica gel changes its color from blue to pink as it absorbs moisture.

(2) Static Electricity

- Static electricity or surge voltage damages the LEDs. It is recommended that a wrist band or an anti-electrostatic glove and shoe be used when handling the LEDs.
- All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.
- when inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to End static-damaged LEDs by a light-on test or a V_F test at a lower current (below 1 mA).
- Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current. (Criteria : $V_F > 2.0V$ at $I_F = 0.5mA$.)

(3) Heat Generation

- Please consider the heat generation of the LED when making the system design that it's very importance. The coefficient of temperature increase per input electric power is effected by the thermal resistance of the circuit board and density of LED placement on the board, and other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- The operating current should be decided after considering the ambient maximum temperature of LEDs.

(4) Others

- Care must be taken to ensure that the reverse voltage will not exceed the absolute maximum rating when using the LEDs with matrix drive.
- The LED light output is strong enough to injure human eyes. Precautions must be taken to prevent looking directly for more than a few seconds. Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.